

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (π -MOSV)

2SK3265

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS

CHOPPER REGULATORS, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

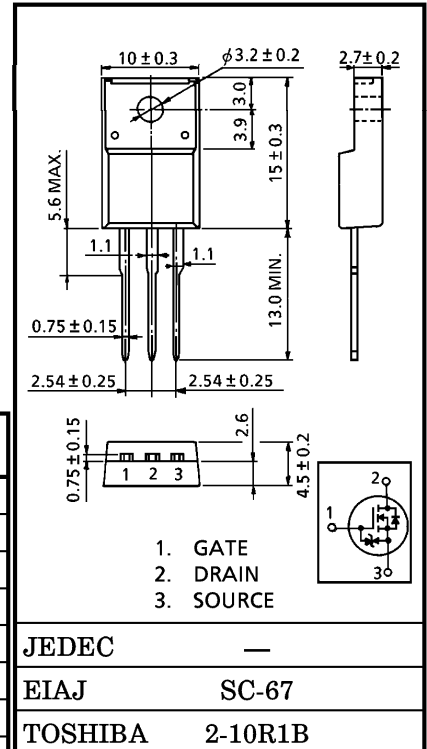
INDUSTRIAL APPLICATIONS

Unit in mm

- Low Drain-Source ON Resistance : $R_{DS(ON)} = 0.72 \Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 7.0 S$ (Typ.)
- Low Leakage Current : $I_{DSS} = 100 \mu A$ (Max.) ($V_{DS} = 700 V$)
- Enhancement-Mode : $V_{th} = 2.0 \sim 4.0 V$
($V_{DS} = 10 V, I_D = 1 mA$)

MAXIMUM RATINGS ($T_a = 25^\circ C$)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DSS}	700	V
Drain-Gate Voltage ($R_{GS} = 20 k\Omega$)	V_{DGR}	700	V
Gate-Source Voltage	V_{GSS}	± 30	V
Drain Current	DC	I_D	10 A
	Pulse	I_{DP}	30 A
Drain Power Dissipation ($T_c = 25^\circ C$)	P_D	45	W
Single Pulse Avalanche Energy**	E_{AS}	420	mJ
Avalanche Current	I_{AR}	10	A
Repetitive Avalanche Energy*	E_{AR}	4.5	mJ
Channel Temperature	T_{ch}	150	$^\circ C$
Storage Temperature Range	T_{stg}	$-55 \sim 150$	$^\circ C$



Weight : 1.9 g (Typ.)

HERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	2.78	$^\circ C/W$
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	62.5	$^\circ C/W$

Note ;

- * Repetitive rating ; Pulse Width Limited by Max. junction temperature.
- ** $V_{DD} = 90 V, T_{ch} = 25^\circ C$ (initial), $L = 7.5 mH, R_G = 25 \Omega, I_{AR} = 10 A$

**This transistor is an electrostatic sensitive device.
Please handle with caution.**

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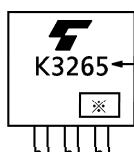
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Gate Leakage Current	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	—	—	±10	μA	
Gate-Source Breakdown Voltage	V _{(BR)GSS}	I _G = ±10 μA, V _{DS} = 0 V	±30	—	—	V	
Drain Cut-off Current	I _{DSS}	V _{DS} = 700 V, V _{GS} = 0 V	—	—	100	μA	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	700	—	—	V	
Gate Threshold Voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	—	4.0	V	
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 5 A	—	0.72	0.75	Ω	
Forward Transfer Admittance	Y _{fs}	V _{DS} = 10 V, I _D = 5 A	4.0	7.0	—	S	
Input Capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	—	1700	—	pF	
Reverse Transfer Capacitance	C _{rss}		—	40	—		
Output Capacitance	C _{oss}		—	200	—		
Switching Time	Rise Time	t _r	<p>V_{GS} 10 V, 0 V, I_D = 5 A, R_L = 40 Ω, V_{DD} ≐ 200 V</p>	—	40	—	ns
	Turn-on Time	t _{on}		—	72	—	
	Fall Time	t _f		—	42	—	
	Turn-off Time	t _{off}		V _{IN} : t _r , t _f < 5 ns, Duty ≤ 1%, t _w = 10 μs	—	145	
Total Gate Charge (Gate-Source Plus Gate-Drain)	Q _g	V _{DD} ≐ 400 V, V _{GS} = 10 V, I _D = 10 A	—	53	—	nC	
Gate-Source Charge	Q _{gs}		—	25	—		
Gate-Drain ("Miller") Charge	Q _{gd}		—	28	—		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I _{IDR}	—	—	—	10	A
Pulse Drain Reverse Current	I _{IDRP}	—	—	—	30	A
Diode Forward Voltage	V _{DSF}	I _{IDR} = 10 A, V _{GS} = 0 V	—	—	-1.9	V
Reverse Recovery Time	t _{rr}	I _{IDR} = 10 A, V _{GS} = 0 V dI _{IDR} /dt = 100 A/μs	—	1400	—	ns
Reverse Recovery Charge	Q _{rr}		—	17.5	—	μC

MARKING



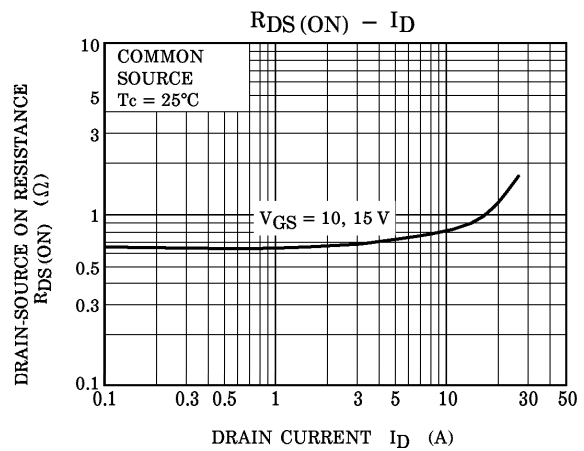
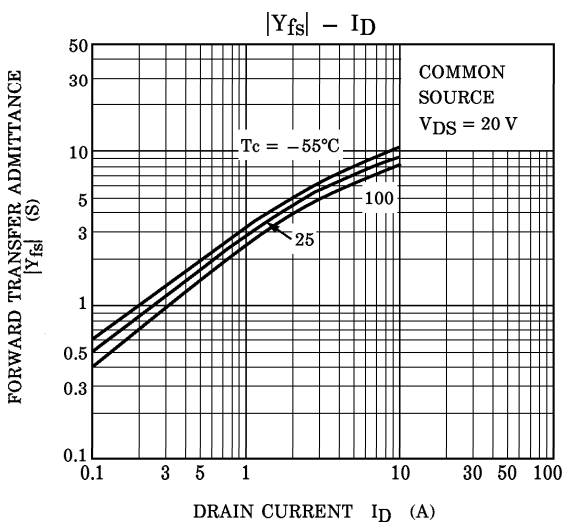
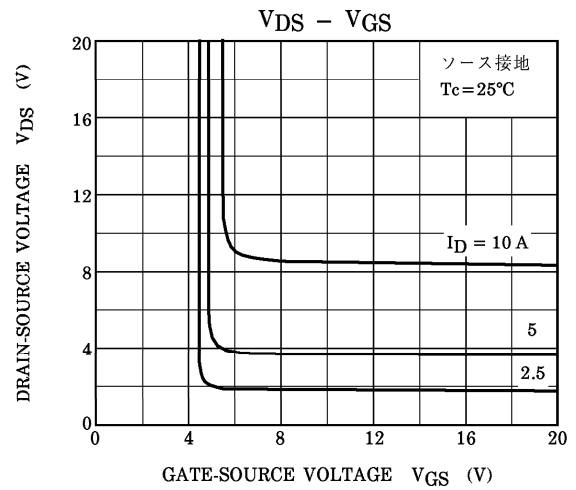
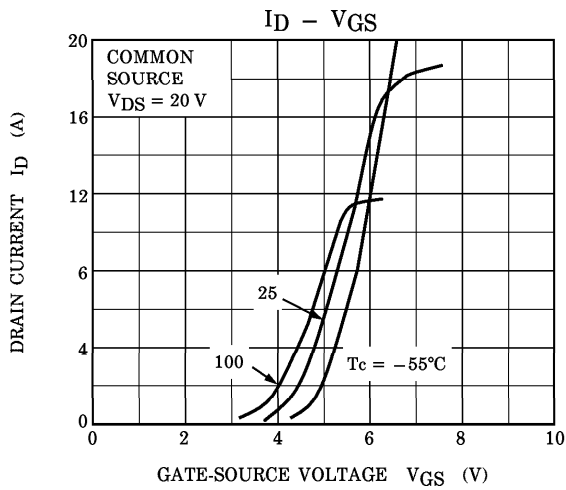
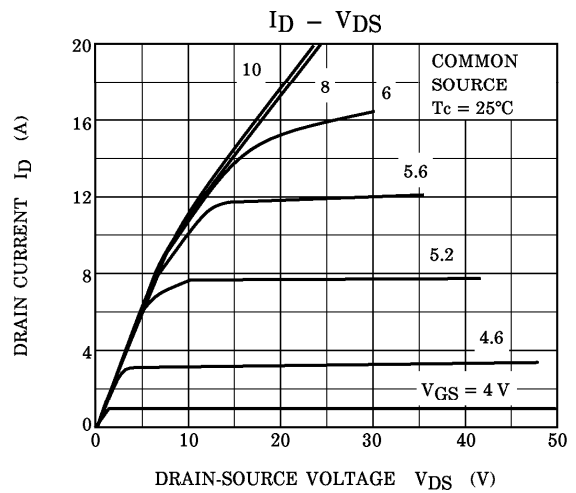
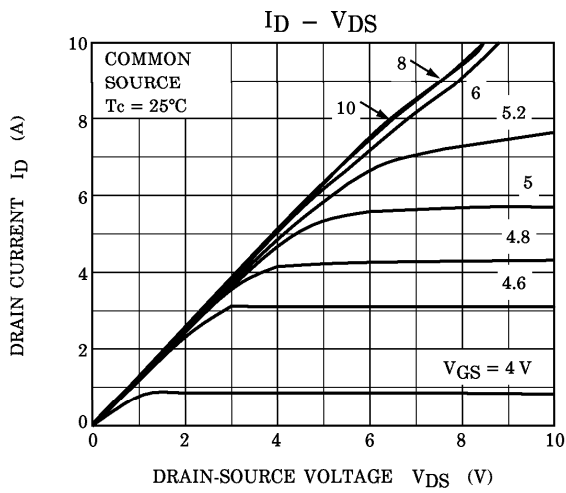
TYPE

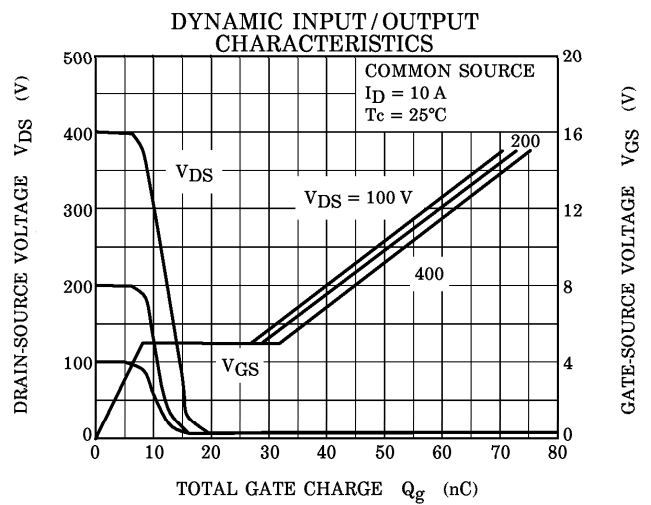
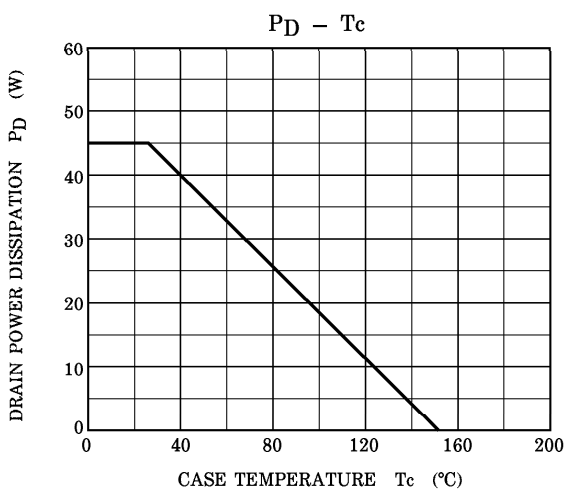
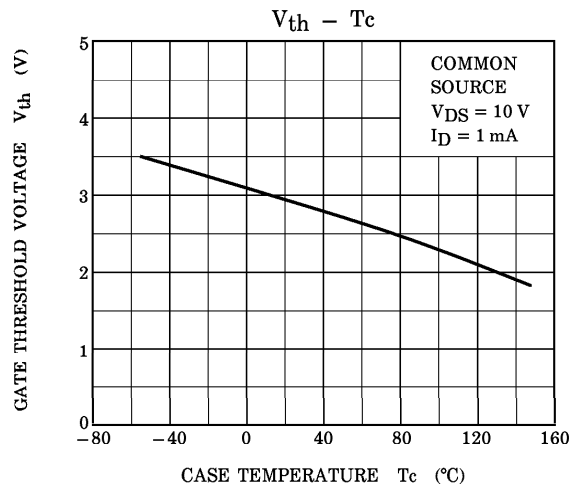
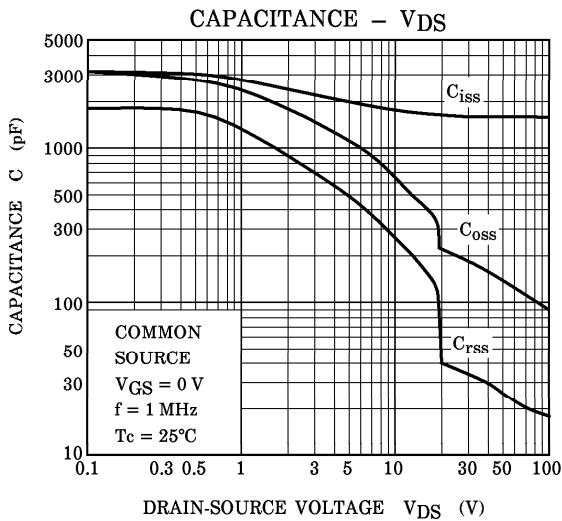
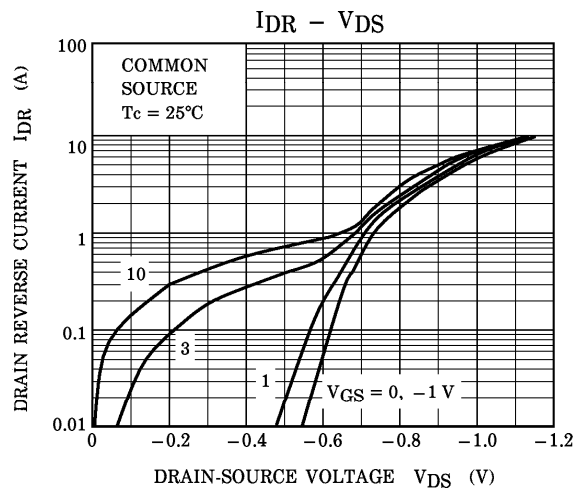
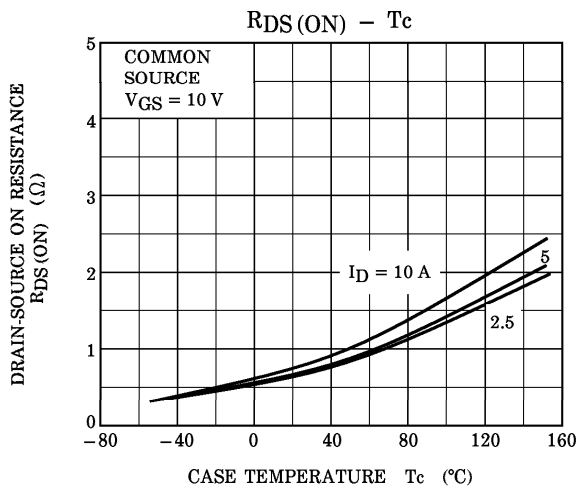
※ Lot Number

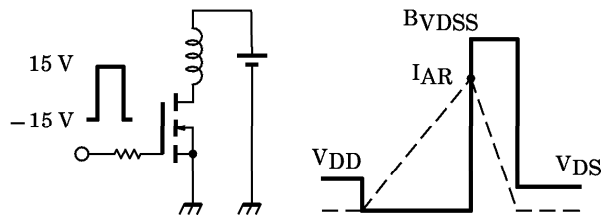
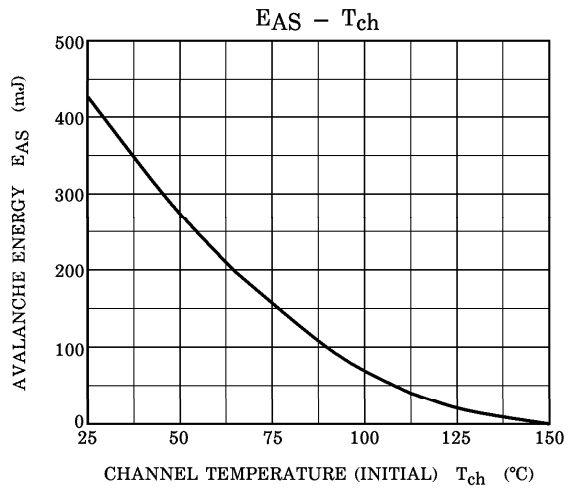
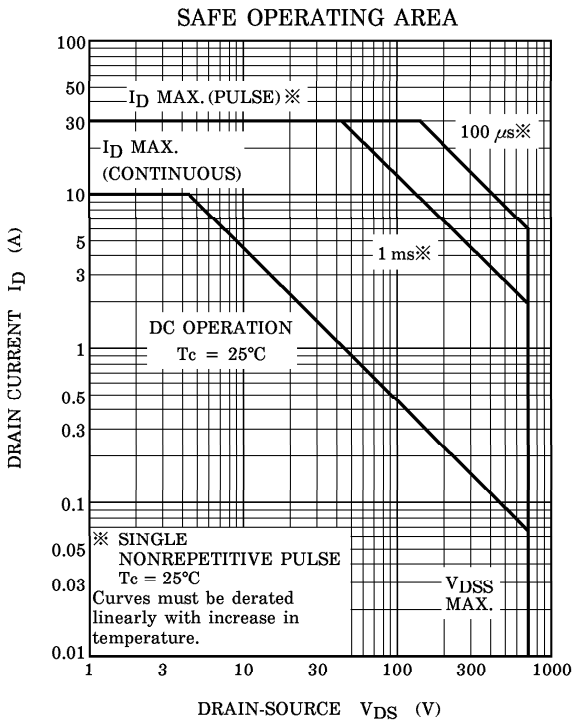
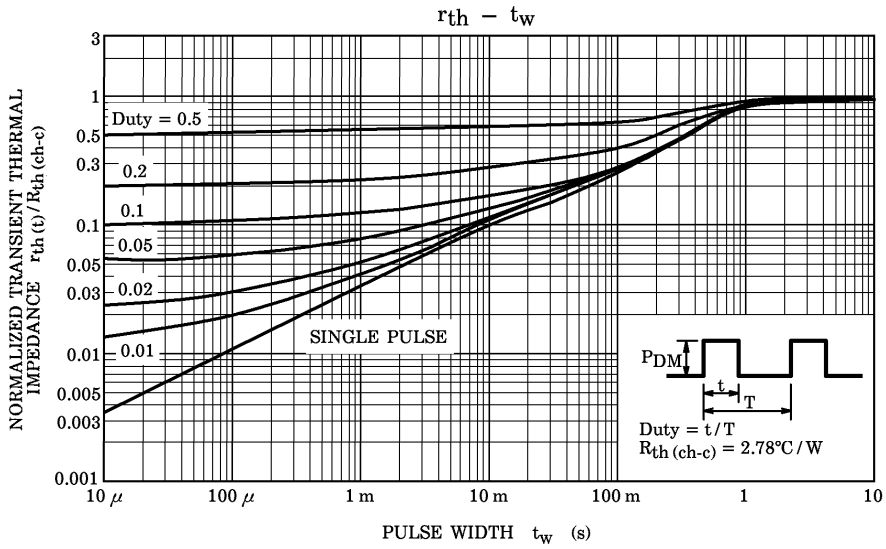


Month (Starting from Alphabet A)

Year (Last Number of the Christian Era)







Peak $I_{AR} = 10$ A, $R_G = 25 \Omega$, $V_{DD} = 90$ V, $L = 7.5$ mH

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$